

### **MICROPOWER, ULTRA-SENSITIVE HALL EFFECT SWITCH**

#### Description

The AH1883 micropower Omnipolar Hall Effect switch IC is designed for portable and battery powered equipment such as cellular phones, cordless phones, camcorders, PDA's, and portable PC's. Based on two high sensitivity Hall Effect plates and chopper stabilized architecture, the AH1883 provides reliable solution over the whole operating range.

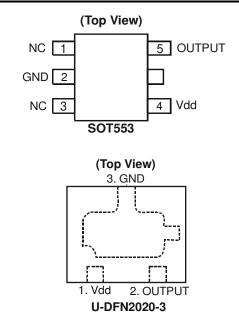
To support portable and battery powered equipment the design has been optimized to operate from 1.65V to 3.3V and consumes 13uW typical with a supply of 1.8V. To minimize PCB space the AH1883 incudes a push-pull output structure, therefore does not require an external pull up resistor, and is packaged in small low profile SOT553 and U-DFN2020-3 packages.

Either North or South pole of sufficient strength will turn the output on. When the magnetic flux density (**B**) is larger than operate (**Bop**) the output is switched on. The output is turned off when B becomes lower than the release point (**Brp**). The output will remain off when there is no magnetic field.

#### **Features**

- Micropower operation
- Operation with North or South Pole
- 1.65V to 3.3V battery operation
- Chopper stabilized
  - Superior temperature stability
  - Extremely Low Switch-Point Drift
  - o Insensitive to Physical Stress
- Good RF noise immunity
- -40°C to 85°C operating temperature
- ESD (HBM) > 6kV in SOT553 and U-DFN2020-3
- Small low profile packages: SOT553 and U-DFN2020-3
- "Green" Molding Compound





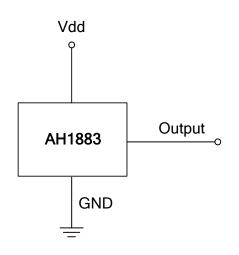
#### Applications

- Cellular phone
- PDA
- Portable PCs Netbook, Notebook, Tablets
- Camcorders
- Cordless phone
- Handheld game consoles
- Proximity detection and contact-less switch applications



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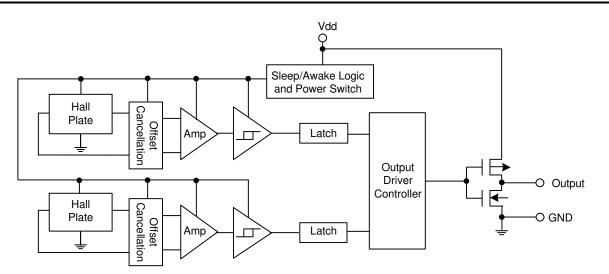
## **Typical Application Circuit**



#### **Pin Descriptions**

Pin Name	P/I/O	Pin #	Description
NC		1	No Connection
GND	P/I	2	Ground
NC		3	No Connection
Vdd	P/I	4	Power Supply Voltage
Output	0	5	Output Pin ( active Low )

### **Functional Block Diagram**





## Absolute Maximum Ratings (T<sub>A</sub> = 25°C, Note 1)

Symbol	Characteristics	Values	Unit	
Vdd	Supply voltage	5	V	
В	Magnetic flux density	Unlimited		
Τ <sub>S</sub>	Storage Temperature Range	-65 to +150	°C	
PD	Package Power Dissipation	230	mW	
TJ	Maximum Junction Temperature	150	°C	

Notes: 1. Stresses greater than the 'Absolute Maximum Ratings' specified above, may cause permanent damage to the device. These are stress ratings only; functional operation of the device at these or any other conditions exceeding those indicated in this specification is not implied. Device reliability may be affected by exposure to absolute maximum rating conditions for extended periods of time

#### **Recommended Operating Conditions (T<sub>A</sub> = 25°C)**

Symbol	Parameter	Conditions	Rating	Unit
Vdd	Supply Voltage	Operating	1.65 to 3.3	V
T <sub>A</sub>	Operating Temperature Range	Operating	-40 to +85	°C

## Electrical Characteristics (T<sub>A</sub> = 25°C, Vdd = 1.8V, unless otherwise specified)

Symbol	Characteristic	Conditions	Min	Тур.	Max	Unit
V <sub>OH</sub>	Output On Voltage (High side)	I <sub>O</sub> = -0.5mA	Vdd-0.2	-	-	V
V <sub>OL</sub>	Output On Voltage (Low side)	I <sub>O</sub> = 0.5mA	-	-	0.2	V
ldd(en)		Chip enable	-	2	4	mA
ldd(dis)	Supply Current	Chip disable	-	5	8	uA
ldd(avg)		average supply current	-	7	12	uA
Tawake	Awake Time		-	50	100	μs
Tperiod	Period		-	50	100	ms
D.C.	Duty Cycle		-	0.1	-	%



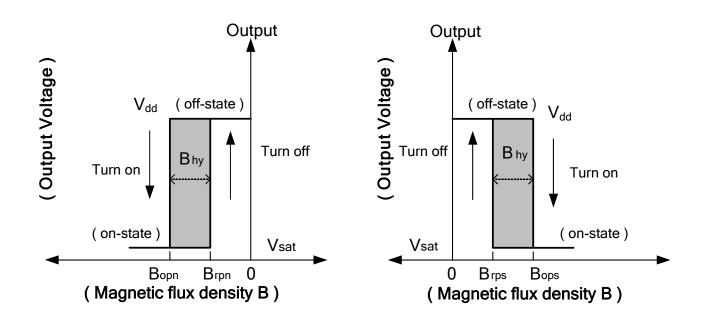
**AH1883** 

## Magnetic Characteristics (T<sub>A</sub> = 25°C, Vdd = 1.8V~3.0V, Note 2 & 3)

				(1m	T=10 Gauss)
Symbol	Characteristic	Min	Тур.	Max	Unit
Bops(south pole to brand side)	Operate Deint	-	37	55	
Bopn(north pole to brand side)	Operate Point	-55	-37	-	
Brps(south pole to brand side)	Deleges Deint	6	29	-	Gauss
Brpn(north pole to brand side)	Release Point	-	-29	-6	
Bhy( Bopx - Brpx )	Hysteresis	3	8	-	

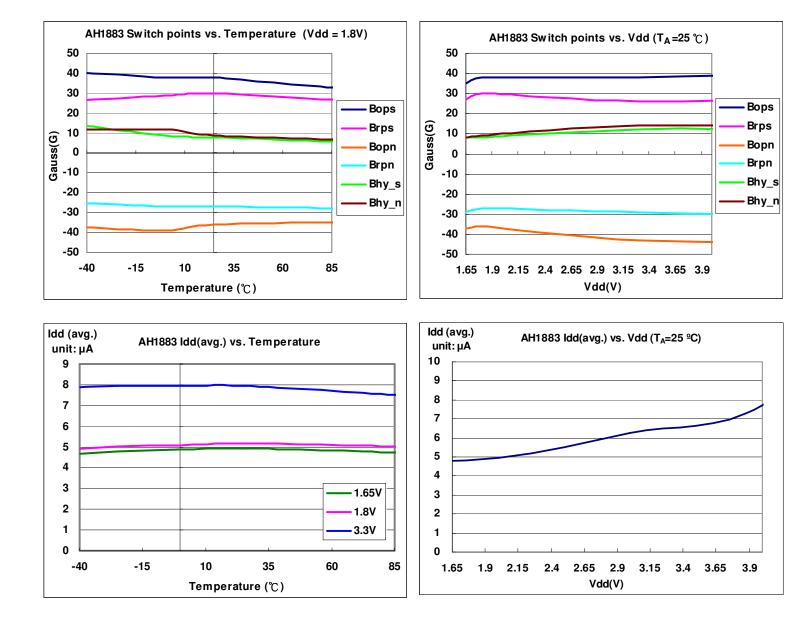
Notes: 2. Typical data is at  $T_A = 25^{\circ}C$ , Vdd = 3V, and for design information only.

3. The magnetic characteristics may vary with supply voltage, operating temperature and after soldering.





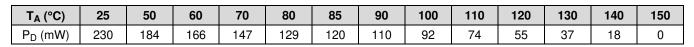
## **Typical Operating Characteristics**

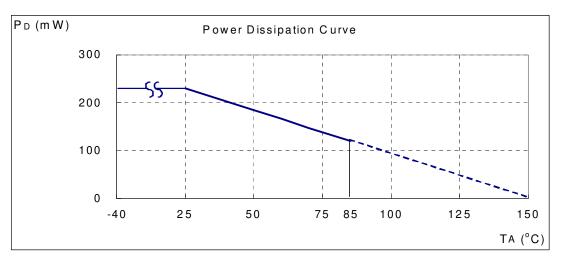




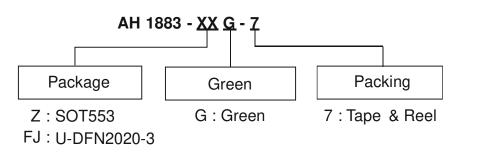
#### **Performance Characteristics**

#### For SOT553 and U-DFN2020-3





### **Ordering Information**



	Device	Package Packaging		7" Tape and Reel		
	Device	Code	(Note 4 & 5)	Quantity	Part Number Suffix	
<b>Pb</b> ,	AH1883-ZG-7	Z	SOT553	3000/Tape & Reel	-7	
Pb,	AH1883-FJG-7	FJ	U-DFN2020-3	3000/Tape & Reel	-7	

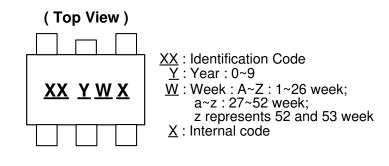
4. EU Directive 2002/95/EC (RoHS). All applicable RoHS exemptions applied. Please visit our website at Notes:

http://www.diodes.com/products/lead\_free.html.
Pad layout as shown on Diodes Inc. suggested pad layout document AP02001, which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf.



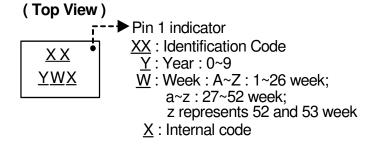
#### **Marking Information**

#### (1) SOT553



Part Number	Package	Identification Code	
AH1883	SOT553	KP	

#### (2) U-DFN2020-3



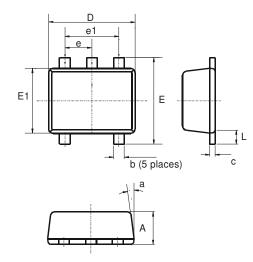
Part Number	Package	Identification Code	
AH1883	U-DFN2020-3	KP	



## MICROPOWER, ULTRA-SENSITIVE HALL EFFECT SWITCH

#### Package Outline Dimensions (All Dimensions in mm)

#### (1) Package Type: SOT553



SOT553					
Dim	Min	Max	Тур		
Α	0.55	0.60	0.60		
С	0.10	0.18	0.15		
D	1.50	1.70	1.60		
Е	1.55	1.70	1.60		
E1	1.10	1.25	1.20		
L	0.10	0.30	0.20		
σ	0.15	0.30	0.20		
е	0.	.50 Typ			
e1	1.	.00 Тур			
а	6°	8°	7°		
	All Dimensions in mm				

U-DFN2020-3

Min Max

0.63

0.05

0.30

2.075

1.30

2.075

1.00

0.45 0.40

0.57

0

0.20

1.95

1.10

1.95

0.80

0.35

All Dimensions in mm

Тур

0.60

0.02

0.152

0.25

2.00

1.20

0.50

2.00

0.90

Dim

Α

A1

A3

b

D

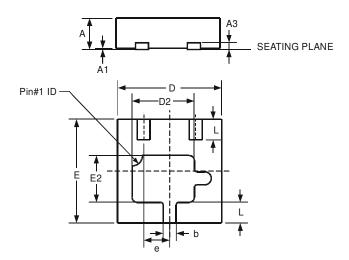
D2

e E

E2

L

#### (2) Package Type: U-DFN2020-3

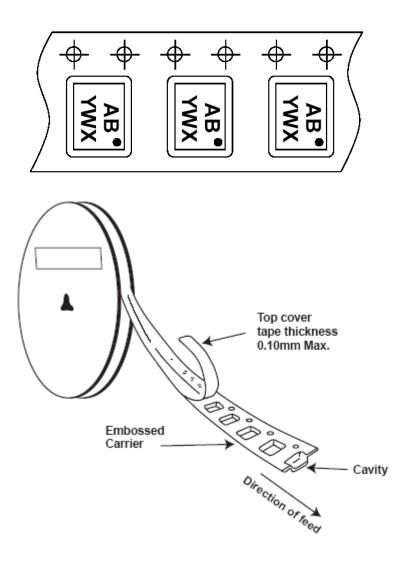




## MICROPOWER, ULTRA-SENSITIVE HALL EFFECT SWITCH

#### **Taping Orientation (Note 6)**

#### For U-DFN2020-3



Notes: 6. The taping orientation of the other package type can be found on our website at http://www.diodes.com/datasheets/ap02007.pdf.



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